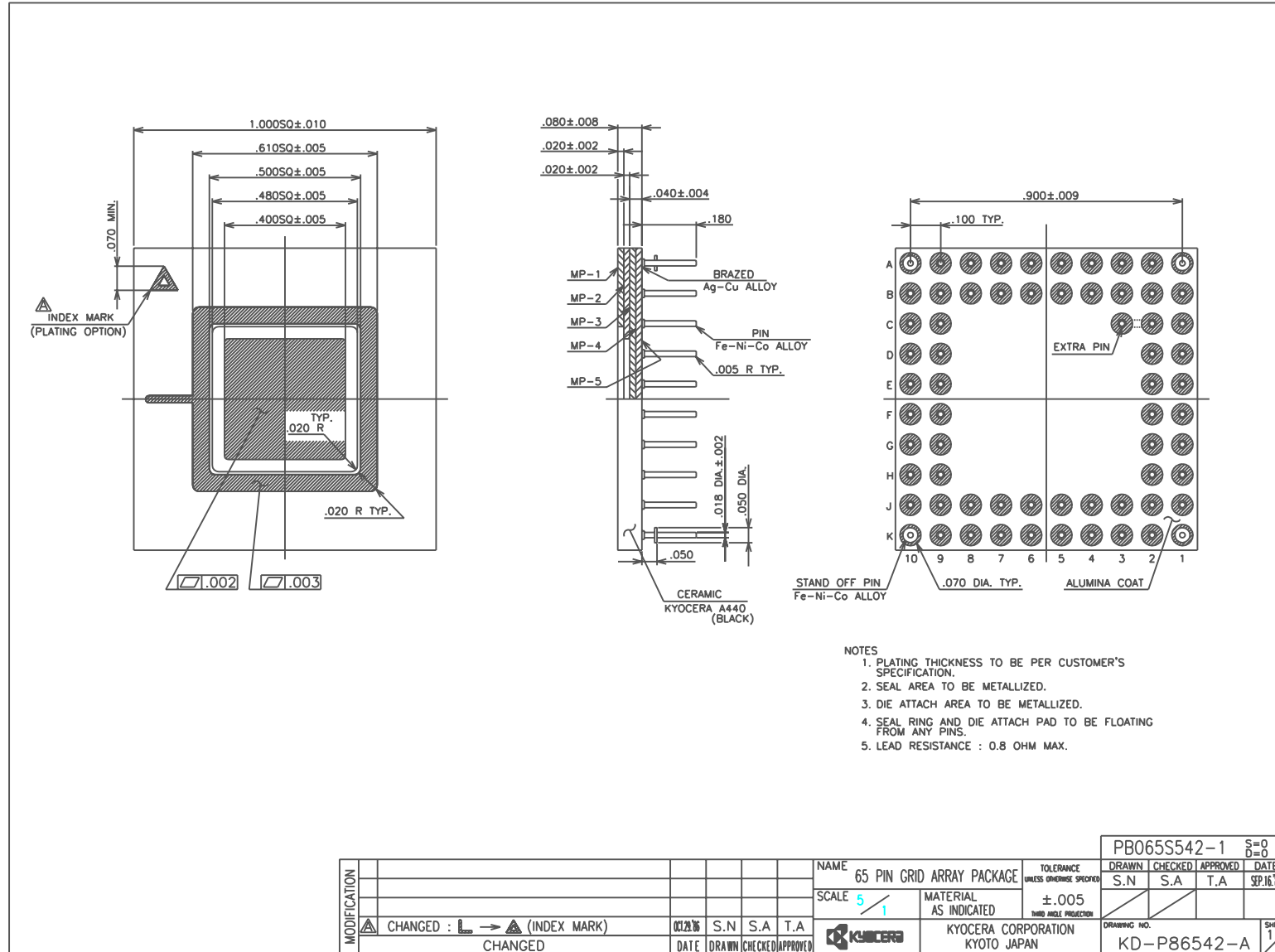
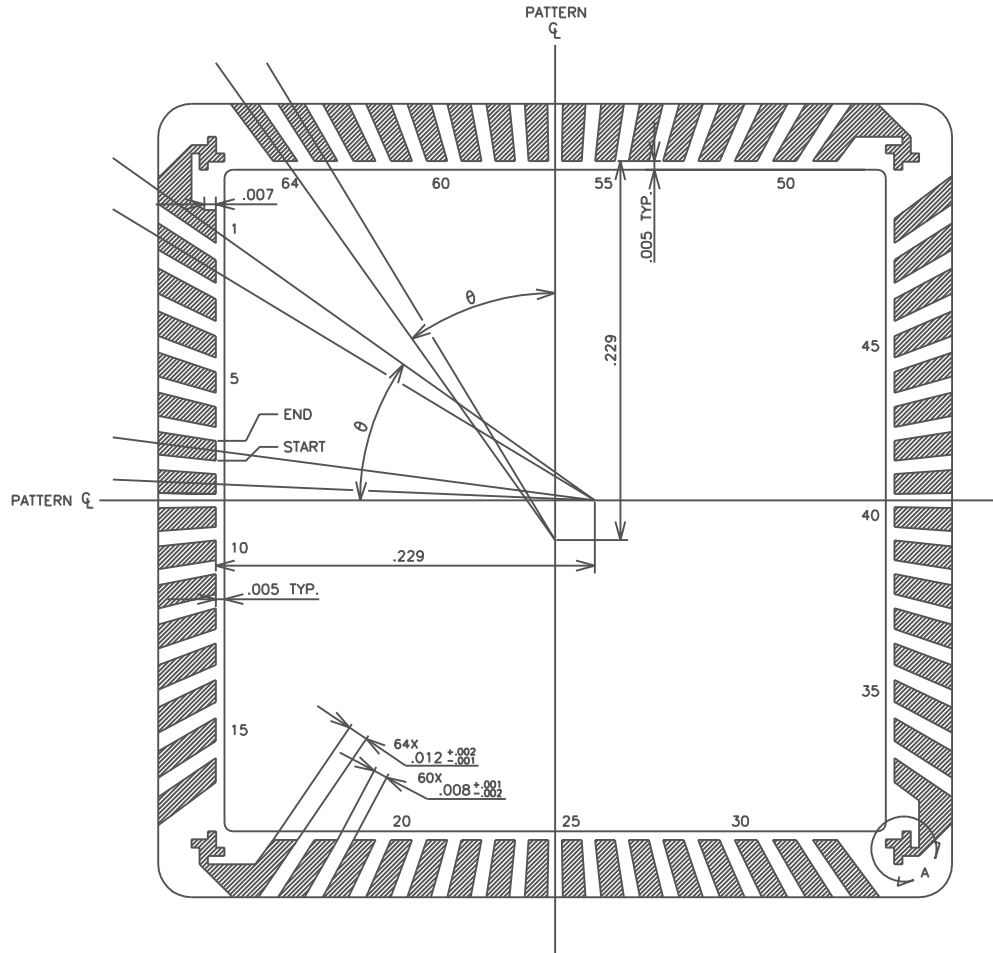
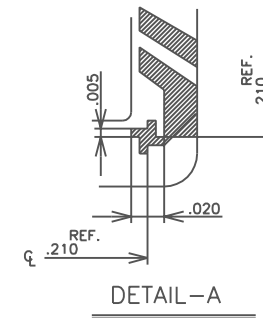


SSM P/N CPG06410





W/B ANGLE θ	W/B EDGES		W/B NO.
	START	END	
2.500	0.0040	0.0180	8,9,24,25,40,41,56,57
7.482	0.0241	0.0361	7,10,23,26,39,42,55,58
12.427	0.0444	0.0566	6,11,22,27,38,43,54,59
17.298	0.0651	0.0776	5,12,21,28,37,44,53,60
22.060	0.0864	0.0993	4,13,20,29,36,45,52,61
26.684	0.1085	0.1219	3,14,19,30,35,46,51,62
31.142	0.1315	0.1455	2,15,18,31,34,47,50,63
35.413	0.1556	0.1703	1,16,17,32,33,48,49,64



BONDING PATTERN

MODIFICATION					NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
					65 PIN GRID ARRAY PACKAGE	UNLESS OTHERWISE SPECIFIED	S.N	S.A	T.A	SEP.16.86
					SCALE	MATERIAL				
					20/1		THIRD ANGLE PROJECTION			
	CHANGED			DATE	DRAWN	CHECKED	APPROVED			KYOCERA CORPORATION KYOTO JAPAN
								DRAWING NO.	KD-P86542-A	
									SHEET 2/3	



WIRE BOND PAD / CONNECTOR PIN INTERCONNECTION PLAN

W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.	W/B NO.	PIN NO.
1	A1	21	J4	41	E10	61	A3
2	C2,C3	22	K4	42	E9	62	B3
3	B1	23	K5	43	D10	63	A2
4	C1	24	J5	44	D9	64	B2
5	D2	25	K6	45	C10		
6	D1	26	J6	46	C9	S/R	NC
7	E1	27	K7	47	B10	D/A	NC
8	E2	28	J7	48	B9		
9	F1	29	K8	49	A10		
10	F2	30	J8	50	B8		
11	G1	31	K9	51	A9		
12	G2	32	J9	52	A8		
13	H1	33	K10	53	B7		
14	H2	34	H9	54	A7		
15	J1	35	J10	55	A6		
16	J2	36	H10	56	B6		
17	K1	37	G9	57	A5		
18	J3	38	G10	58	B5		
19	K2	39	F10	59	A4		
20	K3	40	F9	60	B4		

MODIFICATION					NAME	TOLERANCE	DRAWN	CHECKED	APPROVED	DATE
					65 PIN GRID ARRAY PACKAGE	UNLESS OTHERWISE SPECIFIED	S.N	S.A	T.A	SEP.16.'86
					SCALE	MATERIAL	THIRD ANGLE PROJECTION			
	CHANGED	DATE	DRAWN	CHECKED	APPROVED		KYOCERA CORPORATION KYOTO JAPAN	DRAWING NO. KD-P86542-A		SHEET 3/3

